3.3V 3.2Gbps SONET/SDH LASER DRIVER

SY88912L

FEATURES

- Up to 3.2Gbps operation
- Modulation current to 60mA
- Rise/Fall times <70PS
- Single 3.3V power supply
- Programmable laser modulation current
- Operating temperature range of -40°C to 85°C
- Available in tiny 16-pin MLFTM package

DESCRIPTION

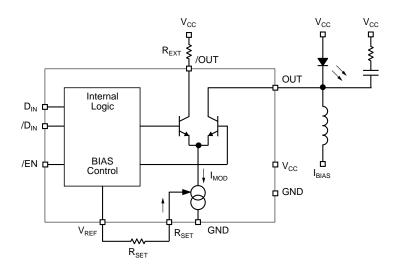
The SY88912L is the smallest laser driver with programmable modulation current for SONET/SDH applications up to 3.2Gbps. The device accepts either PECL or CML level data inputs. The SY88912L provides modulation current of up to 60mA for FP (Fabry-Perot) or DFB (Distributed Feedback) laser.

There is a $75 k\Omega$ pull-down resistor to V_{EE} at the input of /EN. An active low PECL enable signal shuts off modulation current.

APPLICATIONS

- Fiber optical module
- **■** Transponder
- **XAUI CWDM**
- SONET/SDH transmission system
- Add-drop mux
- Metro area network
- 2.5Gbps optical transmitter

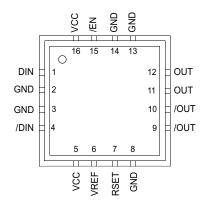
BLOCK DIAGRAM



MLF and Micro LeadFrame are trademarks of Amkor Technology, Inc.

Micrel, Inc. SY88912L

PACKAGE/ORDERING INFORMATION



Ordering Information

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY88912LMI	MLF-16	Industrial	912L	Sn-Pb
SY88912LMITR ⁽¹⁾	MLF-16	Industrial	912L	Sn-Pb
SY88912LMG	MLF-16	Industrial	912L with Pb-Free bar-line indicator	Pb-Free NiPdAu
SY88912LMGTR ⁽¹⁾	MLF-16	Industrial	912L with Pb-Free bar-line indicator	Pb-Free NiPdAu

Note:

1. Tape and Reel.

16-Pin MLF™ (MLF-16)

PIN NAMES

Pin	Function
D _{IN} , /D _{IN}	NRZ differential data inputs.
/EN	PECL compatible active low input.
GND	Most negative power supply input.
OUT, /OUT	Open collector outputs from the modulation driver.
R _{SET}	An external resistor between $V_{\mbox{\scriptsize REF}}$ and $R_{\mbox{\scriptsize SET}}$ defines the modulation current.
V _{CC}	Most positive power supply input.
V _{REF}	Voltage reference for use with R _{SET} .

TRUTH TABLE(1)

D	/D	/EN	OUT ⁽²⁾	/OUT
L	Н	L H		L
Н	L	L	L	Н
Х	Х	Н	Н	L

Notes:

- 1. L = LOW, H = HIGH, X = don't care.
- 2. $I_{OUT} \le I_{MOD_OFF}$ when /EN is HIGH.

ABSOLUTE MAXIMUM RATINGS(1)

Symbol	Parameter		Value	Unit
V _{CC}	Power Supply Voltage		0 to +5.0	V
V _{IN}	Input Voltage		0 to V _{CC}	V
I _{OUT}	Output Current		65	mA
T _{store}	Storage Temperature		-55 to +125	°C
T _A	Operating Temperature		-40 to +85	°C
P _D	Power Dissipation		500	mW
$\theta_{JA}^{(2)}$	Package Thermal Resistance (Junction-to-Ambient)	–Still-Air	59	°C/W
ΨЈВ	Package Thermal Resistance (Junction-to-Board)		32.1	°C/W

Note:

OPERATING CONDITIONS

Symbol	Parameter	Value	Unit
V _{CC}	Power Supply Voltage	+3.15 to +3.45	V
R _{EXT} ⁽¹⁾	Resistor to Dissipate Power	5 (Min.)	Ω
R _{SET}	Resistor to Set I _{MOD}	100 to 10,000	Ω

Note:

^{1.} Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

^{2.} JEDEC standard test boards with DIE attach pads soldered to PCB.

^{1.} Refer to $\rm V_{OUT}$ specification.

Micrel, Inc. SY88912L

DC ELECTRICAL CHARACTERISTICS

 $V_{CC} = 3.15 \text{ to } 3.45 \text{V}; \text{ GND} = 0 \text{V}; T_{A} = -40 ^{\circ}\text{C to } +85 ^{\circ}\text{C}$

Symbol	Parameter	Min.	Typ. ⁽²⁾	Max.	Unit	Condition
I _{CC}	Power Supply Current ⁽¹⁾	_	65	80	mA	$I_{MOD} = 60 \text{mA}$
I _{MOD}	Modulation Current Range	10		60	mA	
I _{MOD_OFF}	Modulation Off Current ⁽²⁾			200	μΑ	/EN = V _{IHEN}
V _{IDDIN}	Input Differential Voltage, D_{IN} , $/D_{IN}$	200	_	1600	mV_{PP}	(3)
V _{IHDIN}	Input HIGH Voltage, D _{IN} , /D _{IN}	V _{CC} -1.7		V _{CC} −0.1	V	
V _{ILDIN}	Input LOW Voltage, D _{IN} , /D _{IN}	V _{CC} -1.9		V _{CC} -0.3	V	
V _{IHEN}	Input HIGH Voltage, /EN	V _{CC} -1165		V _{CC} –880	mV	
V _{ILEN}	Input LOW Voltage, /EN	V _{CC} -1810		V _{CC} -1475	mV	
V _{OUT}	Output Voltage, OUT, /OUT	V _{CC} -1.5	_	V _{CC}	V	(4)
V _{REF}	Reference Voltage1.5	1.7	1.9	V		

Notes:

- 1. Excluding I_{MOD} . $I_{MOD} \le 60 \text{mA}$
- 2. Typical values are under $\rm V_{CC}$ = 3.3V and $\rm T_A$ = 25°C.
- 3. V_{IDDIN} is the voltage required to guarantee a stable logic level. For a logic "1", D_{IN} must be V_{IDDIN} above D_{IN} . For stable logic "0", D_{IN} must be V_{IDDIN} below D_{IN} .
- 4. OUT and /OUT are current outputs. This specification defines the voltage range that the user must guarantee these pins remain within proper operation.

AC ELECTRICAL CHARACTERISTICS(1)

 $V_{CC} = 3.15 \text{ to } 3.45 \text{V}; \text{ GND} = 0 \text{V}; T_{A} = -40 ^{\circ}\text{C to } +85 ^{\circ}\text{C}$

Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
D_J	Jitter Generation ^{(2),(3)}	_	_	20	ps	peak-to-peak
t _r , t _f	Rise/Fall Times ⁽²⁾ (20% to 80%)	_	65	_	ps	

Notes:

- 1. AC characteristics are guaranteed by design and characterization.
- 2. $\rm I_{MOD}$ = 40mA, 25 Ω resistors each tied from OUT and /OUT to $\rm V_{CC}.$
- 3. I_{MOD} = 40mA, 2.5Gbps, 0-1 pattern, BW = 12KHz to 20MHz.

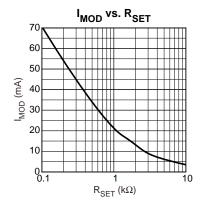
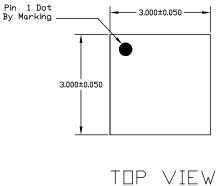
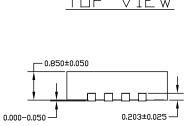


Figure 1. I_{MOD} vs. R_{SET}

Micrel, Inc. SY88912L

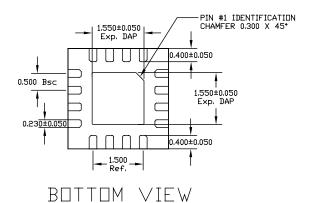
16 LEAD EPAD-*Micro* LEADFRAME™ (MLF-16)





SIDE

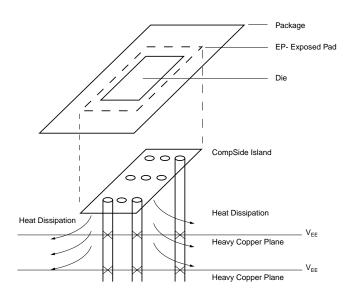
VIFW



NOTE

- ALL DIMENSIONS ARE IN MILLIMETERS.
 MAX. PACKAGE WARPAGE IS 0.05 mm.
 MAXIMUM ALLDWABE BURRS IS 0.076 mm IN ALL DIRECTIONS.
 PIN #1 ID IN TOP WILL BE LASER/INK MARKED.

Rev. 01



PCB Thermal Consideration for 16-Pin MLF™ Package

MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA

TEL + 1 (408) 944-0800 FAX + 1 (408) 474-1000 WEB http://www.micrel.com

The information furnished by Micrel in this data sheet is believed to be accurate and reliable. However, no responsibility is assumed by Micrel for its use. Micrel reserves the right to change circuitry and specifications at any time without notification to the customer.

Micrel Products are not designed or authorized for use as components in life support appliances, devices or systems where malfunction of a product can reasonably be expected to result in personal injury. Life support devices or systems are devices or systems that (a) are intended for surgical implant into the body or (b) support or sustain life, and whose failure to perform can be reasonably expected to result in a significant injury to the user. A Purchaser's use or sale of Micrel Products for use in life support appliances, devices or systems is at Purchaser's own risk and Purchaser agrees to fully indemnify Micrel for any damages resulting from such use or sale.

© 2005 Micrel, Incorporated.